



**elm** kimya

## Homopolymer General Purpose Grade Resin

**F680H** is especially suited for processing from powder blends due to its ability to rapidly absorb plasticizers regardless of molecular weight. In addition, this product offers:

*Excellent Electrical Properties	*Low Contamination
*Low Gel Content	*Excellent Heat Stability
*High Finished Product Physical Properties	*Lot To Lot Uniformity

## **Suggested Applications:**

Flexible Calendering, Extrusion, Medical, Meat Wrap and Blown Film.

<u>Properties</u>	Test Method	<u>Typical Value</u>
Relative Viscosity Inherent Viscosity K-Value	estimated ASTM D-5225 estimated	2.37 1.02 70
Volatiles (%) Bulk Density (lbs/ft3) (g/cc)	ASTM D-6980 ASTM D-1895	0.20 32 0.51
Sieve Analysis % thru 40 Mesh % thru 200 Mesh	Malvern	99.9 4
Residual VCM (ppm) Contamination Count Gel Count	GC Head Space Method OCS per 100g GP Gel Method	<1.0 20 10

Effective as of November 2015



Any inquiries regarding this data sheet should be addressed to: 9 Peach Tree Hill Road • Livingston, NJ 07039 • Phone: (888) FPCUSA3 • Fax: (973) 422-7724

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